

## INNATE™ ST50 Precision Packaging Resin

### The Dow Chemical Company - Precision Packaging Resin

Tuesday, November 5, 2019

#### **General Information**

#### **Product Description**

INNATE™ ST50 Precision Packaging Resin is designed for exceptional abuse performance. It offers a unique combination of high stiffness with excellent toughness which enables excellent performance on automated packaging equipment. This product also delivers robust processability.

#### Complies with:

- Europe Commission Regulation (EU) No 10/2011
- U.S. FDA FCN 424
- · JHOSPA (Japan Hygienic Olefin and Styrene Plastics Association)

Consult the regulations for complete details

General				
Material Status	Commercial: Active			
Availability	<ul><li>Asia Pacific</li><li>Europe</li></ul>	<ul><li>Latin America</li><li>North America</li></ul>		
Agency Ratings	• EU 2011/10/EC	• FDA FCN 424	<ul> <li>JHOSPA Unspecified Rating</li> </ul>	
Forms	Pellets			

Density / Specific Gravity  Melt Mass-Flow Rate (190°C/2.16 kg)  Films  N  Film Thickness - Tested  Film Puncture Energy  Film Puncture Force  Film Puncture Resistance  Secant Modulus - 2% Secant, MD  Secant Modulus - 2% Secant, TD  Tensile Strength - MD (Yield)  Tensile Strength - TD (Yield)	0.920 0.85		Test Method
Melt Mass-Flow Rate (190°C/2.16 kg)  Films N  Film Thickness - Tested  Film Puncture Energy  Film Puncture Force  Film Puncture Resistance  Secant Modulus - 2% Secant, MD  Secant Modulus - 2% Secant, TD  Tensile Strength - MD (Yield)  Tensile Strength - TD (Yield)			
Films  Film Thickness - Tested  Film Puncture Energy  Film Puncture Force  Film Puncture Resistance  Secant Modulus - 2% Secant, MD  Secant Modulus - 2% Secant, TD  Tensile Strength - MD (Yield)  Tensile Strength - TD (Yield)	0.85		ASTM D792
Film Thickness - Tested Film Puncture Energy Film Puncture Force Film Puncture Resistance Secant Modulus - 2% Secant, MD Secant Modulus - 2% Secant, TD Tensile Strength - MD (Yield) Tensile Strength - TD (Yield)		g/10 min	ASTM D1238
Film Puncture Energy Film Puncture Force Film Puncture Resistance Secant Modulus - 2% Secant, MD Secant Modulus - 2% Secant, TD Tensile Strength - MD (Yield) Tensile Strength - TD (Yield)	ominal Value	Unit	Test Method
Film Puncture Force Film Puncture Resistance Secant Modulus - 2% Secant, MD Secant Modulus - 2% Secant, TD Tensile Strength - MD (Yield) Tensile Strength - TD (Yield)	2	mil	
Film Puncture Resistance Secant Modulus - 2% Secant, MD Secant Modulus - 2% Secant, TD Tensile Strength - MD (Yield) Tensile Strength - TD (Yield)	81.0	in·lb	
Secant Modulus - 2% Secant, MD Secant Modulus - 2% Secant, TD Tensile Strength - MD (Yield) Tensile Strength - TD (Yield)	23.5	lbf	
Secant Modulus - 2% Secant, TD  Tensile Strength - MD (Yield)  Tensile Strength - TD (Yield)	272	ft·lb/in³	
Tensile Strength - MD (Yield) Tensile Strength - TD (Yield)	28500	psi	ASTM D882
Tensile Strength - TD (Yield)	33400	psi	ASTM D882
· ,	1470	psi	ASTM D882
	1570	psi	ASTM D882
Tensile Strength - MD (Break)	7500	psi	ASTM D882
Tensile Strength - TD (Break)	7350	psi	ASTM D882
Tensile Elongation - MD (Break)	570	%	ASTM D882
Tensile Elongation - TD (Break)	660	%	ASTM D882
Dart Drop Impact <sup>2</sup>	1900	g	ASTM D1709
Elmendorf Tear Strength - MD	570	g	ASTM D1922
Elmendorf Tear Strength - TD	940	g	ASTM D1922
Thermal N	ominal Value	Unit	Test Method
Vicat Softening Temperature	219	°F	ASTM D1525
Melting Temperature (DSC)	255	°F	Internal Method
Optical N	ominal Value	Unit	Test Method
Gloss (45°)	51		ASTM D2457
Haze			



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#### **Additional Information**

Fabrication Conditions for 2 mil monolayer blown film at 100%:

Die Diameter: 8 in.Screw Type: DSB IIDie Gap: 90 mil

• Melt Temperature: 432 °F

• Output: 10.34 lb/hr/in. of die circumference

Screw Size: 3.5 in.
Blow-Up Ratio: 2.5 to 1
Screw Speed: 36 rpm
Frost Line Height:40 in.

#### **Notes**

<sup>1</sup> Typical properties: these are not to be construed as specifications.

<sup>2</sup> Method A

